

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Conf. No.:

7795

Signey, et al.

In re the Application of:

Docket No.:

TI-27954

Serial No.: 09/975,219

Examiner: Windmuller, J.

Filed:

10/11/2001

Art Unit:

3724

For:

Method and System for Cutting Integrated Circuit Packages

Response under 37 CFR 1.111

TECHNOLOGY CENTER R3700

Commission for Patents P.O. Box 1450 Alexandria, VA 22313-1450 MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on

mber 11, 2003.

Dear Sir:

The following amendments and remarks are offered in response to the Examiner's Office Action dated 06/12/03. They are respectfully submitted as a full and complete response to that Action. The Commissioner is hereby requested and authorized to charge any fees necessary for the filing of the enclosed papers to deposit account number 20-0668 of Texas Instruments Incorporated.